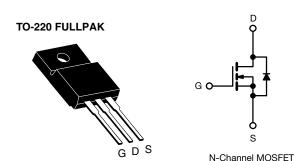
Vishay Siliconix

D Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.28			
Q _g max. (nC)	76			
Q _{gs} (nC)	11			
Q _{gd} (nC)	17			
Configuration	Single			

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- · Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Consumer electronics
- Displays (LCD or Plasma TV)
- Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- · Battery chargers

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF18N50D-E3

ABSOLUTE MAXIMUM RATINGS $(T_C$	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	500	
Gate-source voltage			V _{GS}	± 30	V
Gate-source voltage AC (f > 1 Hz)				30	
Continuous drain surrent /T 150 °C) 6	V at 10 V	T _C = 25 °C	,	18	
Continuous drain current ($T_J = 150 ^{\circ}\text{C}$) e V_{GS} at 10 V $\frac{T_C = 25 ^{\circ}\text{C}}{T_C = 100 ^{\circ}\text{C}}$		T _C = 100 °C	I _D	11	Α
Pulsed drain current ^a			I _{DM}	53	
Linear derating factor				0.3	W/°C
Single pulse avalanche energy b			E _{AS}	115	mJ
Maximum power dissipation			P_{D}	39	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope T _J = 125 °C		dV/dt	24	\//no	
Reverse diode dV/dt ^d			0.4	- V/ns	
Soldering recommendations (peak temperature) ^c	For 10 s			300	°C
Mounting torque	M3 screw			0.6	Nm

- Repetitive rating; pulse width limited by maximum junction temperature $V_{DD}=50$ V, starting $T_J=25$ °C, L = 2.3 mH, $R_g=25$ Ω , $I_{AS}=10$ A
- 1.6 mm from case
- $I_{SD} \le I_{D}$, starting $T_{J} = 25 \, ^{\circ}\text{C}$ Limited by maximum junction temperature



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	65	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	3.2	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate threshold voltage (N)	V _{GS(th)}	V _{DS} =	: V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	_	± 100	nA
7		V _{DS} =	: 500 V, V _{GS} = 0 V	-	-	1	μА
Zero gate voltage drain current	I _{DSS}	V _{DS} = 400 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	10	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 9 A	-	0.23	0.28	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 9 A	-	6.4	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	1500	-	
Output capacitance	C _{oss}		V _{DS} = 100 V,	-	131	-	
Reverse transfer capacitance	C _{rss}	V _{DS} = 100 V, - 131 - 14 - 113		-	pF		
Effective output capacitance, energy related ^a	C _{o(er)}			-			
Effective output capacitance, time related ^b	$C_{o(tr)}$	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{ V to } 400 \text{ V}$		-	164	-	
Total gate charge	Qg			-	38	76	
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 9 A, V _{DS} = 400 V		-	11	-	nC
Gate-drain charge	Q_{gd}]		17	-	
Turn-on delay time	$t_{d(on)}$			-	19	38	
Rise time	t _r	$V_{DD} = 400 \text{ V}, I_D = 9 \text{ A},$		-	36	72	ns
Turn-off delay time	t _{d(off)}	V _{GS} =	$=$ 10 V, R _g = 9.1 Ω	-	36	72	115
Fall time	t _f			-	30	60	
Gate input resistance	Rg	f = 1	MHz, open drain	-	1.7	-	Ω
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	I _S	MOSFET sym showing the	bol	-	-	18	
Pulsed diode forward current	I _{SM}	integral reverse P - N junction diode		-	-	72	A
Diode forward voltage	V _{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 9 \text{A}, V_{GS} = 0 \text{V}$		-	-	1.2	V
Reverse recovery time	t _{rr}			-	354	-	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 9 \text{A},$		-	μC		
Reverse recovery current	I _{RRM}	dl/dt = 100 A/ μ s, V_R = 20 V		-	A		

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

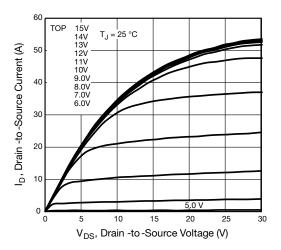


Fig. 1 - Typical Output Characteristics

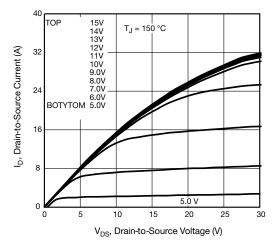


Fig. 2 - Typical Output Characteristics

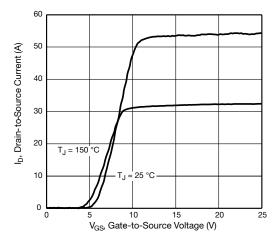


Fig. 3 - Typical Transfer Characteristics

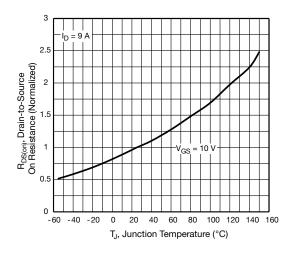


Fig. 4 - Normalized On-Resistance vs. Temperature

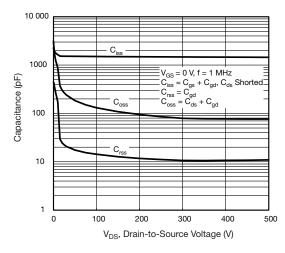


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

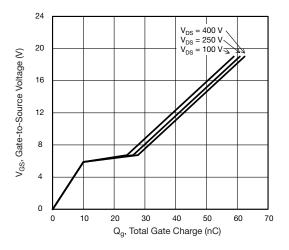


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



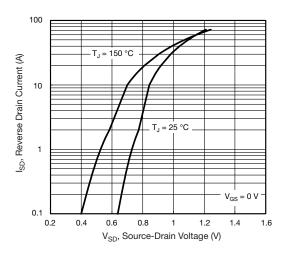


Fig. 7 - Typical Source-Drain Diode Forward Voltage

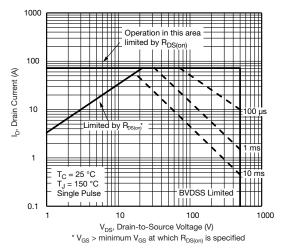


Fig. 8 - Maximum Safe Operating Area

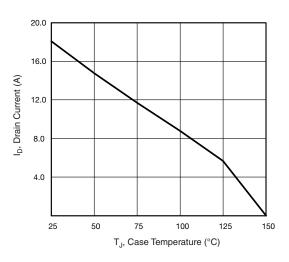


Fig. 9 - Maximum Drain Current vs. Case Temperature

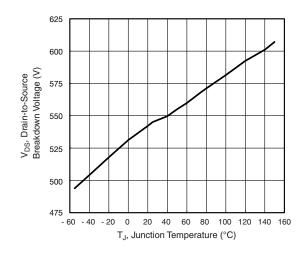


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

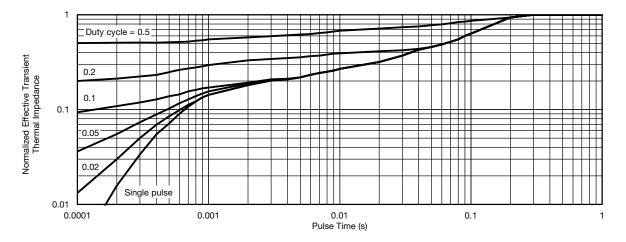


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



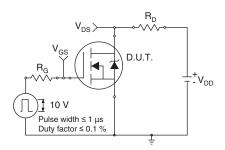


Fig. 12 - Switching Time Test Circuit

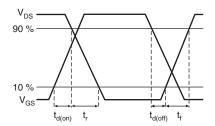


Fig. 13 - Switching Time Waveforms

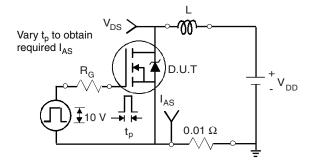


Fig. 14 - Unclamped Inductive Test Circuit

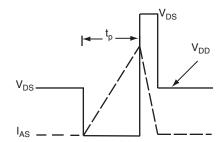


Fig. 15 - Unclamped Inductive Waveforms

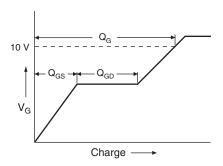


Fig. 16 - Basic Gate Charge Waveform

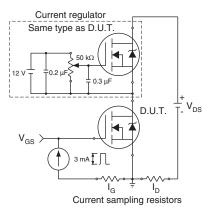
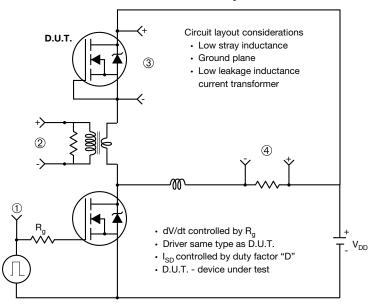


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



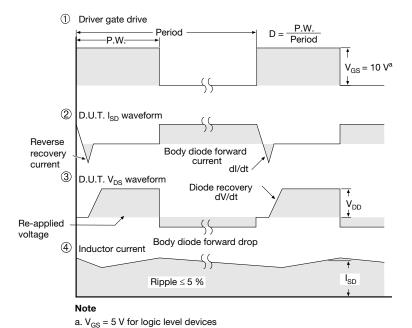


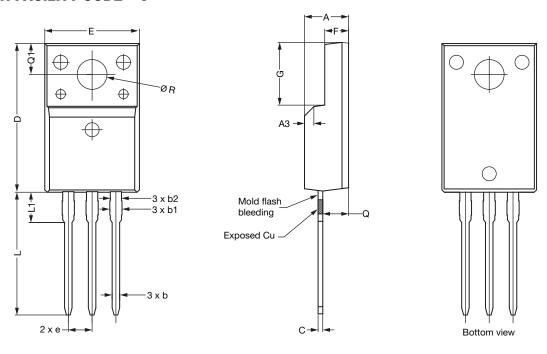
Fig. 18 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91507.

Vishay Siliconix

TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9

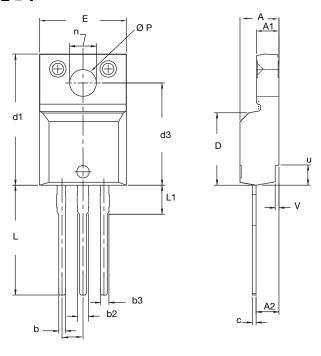


		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
Α	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



OPTION 2: FACILITY CODE = Y



	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
Е	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØΡ	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

ECN: E19-0180-Rev. D, 08-Apr-2019

DWG: 5972

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